





### **3A SBR® SUPER BARRIER RECTIFER**

### **Features**

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

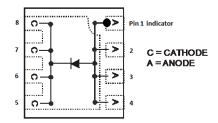
### **Mechanical Data**

- Case: U-DFN3030-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0172 grams (Approximate)

U-DFN3030-8



**Bottom View** 



Top View Schematic and Pin Configuration

## **Ordering Information** (Note 4)

Part Number	Case	Packaging
SBR3U100LP-7	U-DFN3030-8	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



3U10 = Product marking code YYWW = Date code marking YY = Last digit of year (ex: 18 for 2018) WW = Week code (01 ~ 53)



### **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single-phase, half-wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	100	V
RMS Reverse Voltage	$V_{R(RMS)}$	70	V
Average Rectified Output Current	lo	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	32	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 5) $T_A = +25$ °C	$R_{\Theta JA}$	61	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

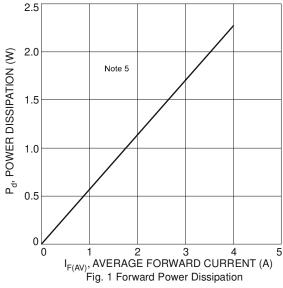
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	100	_	_	V	$I_R = 0.2mA$
Forward Voltage	$V_{F}$	_	_	0.79	V	$I_F = 3.0A, T_J = +25^{\circ}C$
Reverse Current (Note 6)	1-	_	16	200	μΑ	$V_R = 100V, T_J = +25$ °C
	IR		3	15	mA	$V_R = 100V, T_J = +125^{\circ}C$

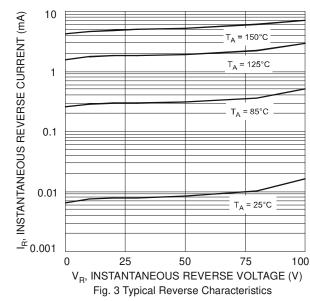
Notes:

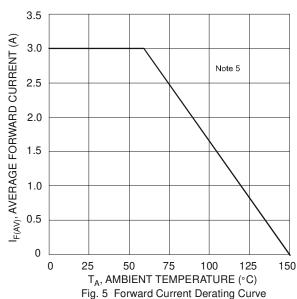
- 5. Device mounted on Polyimide substrate, 2 oz. Copper, 75mm² pad area, double side PCB.
  6. Short duration pulse test used to minimize self-heating effect.

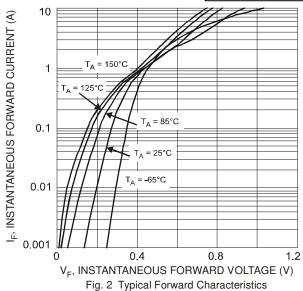


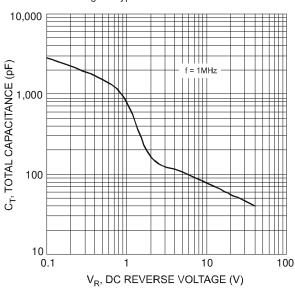


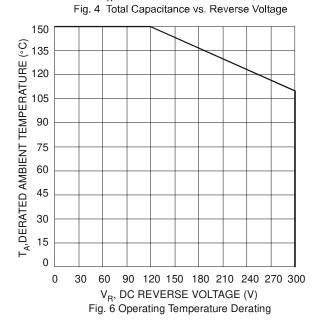










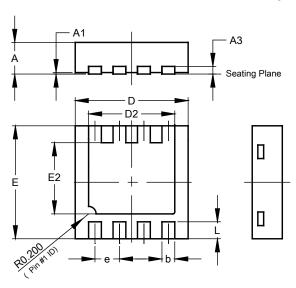




## **Package Outline Dimensions**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

### U-DFN3030-8

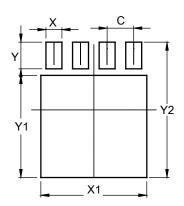


U-DFN3030-8					
Dim	Min	Max	Тур		
Α	0.57	0.63	0.60		
<b>A</b> 1	0	0.05	0.02		
<b>A</b> 3	-	-	0.15		
b	0.29	0.39	0.34		
D	2.90	3.10	3.00		
D2	2.19	2.39	2.29		
е	-	-	0.65		
Е	2.90	3.10	3.00		
E2	1.64	1.84	1.74		
L	0.30	0.60	0.45		
All Dimensions in mm					

# **Suggested Pad Layout**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

### U-DFN3030-8



Dimensions	Value		
Dillielisions	(in mm)		
С	0.650		
Х	0.390		
X1	2.590		
Υ	0.650		
Y1	2.490		
V2	3 300		



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